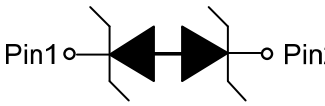
1-Line, Bi-directional, Transient Voltage Suppressor



DFN1006-2L

Features

- Stand-off voltage: 5V Max
- Transient protection for each line according to
  IEC61000-4-2(ESD): ±30kV (contact)
  IEC61000-4-5(surge): 8A (8/20μs)
- Low leakage current
- Low clamping voltage
- Compliant

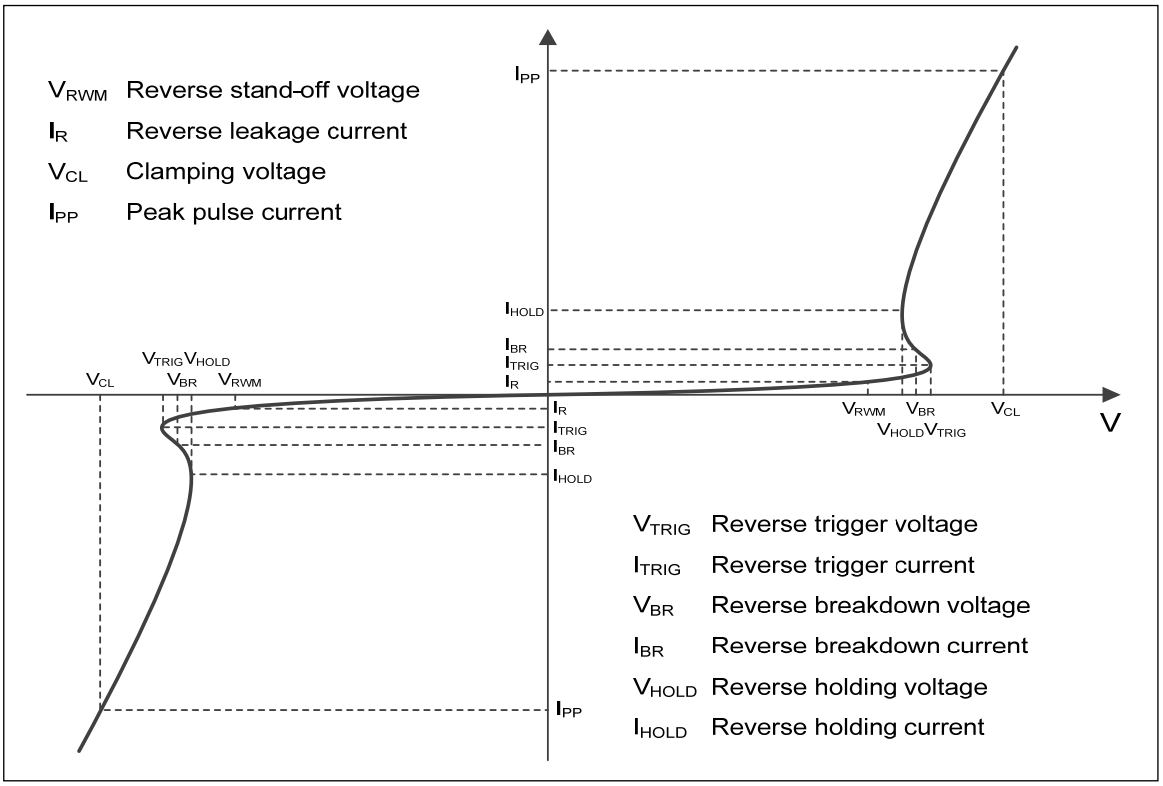
Applications

- Cellular handsets
- Tablets
- Laptops
- Network communication devices
- Other portable devices

Mechanical Data

- Package: DFN1006-2L
- Case Material: “Green” Molding Compound
- Marking Information: See Below
- Marking:

■Definitions of electrical characteristics



■Maximum Ratings

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power (t_p = 8/20μs)	P_{pk}	96	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	8	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	KV
ESD according to IEC61000-4-2 contact discharge		±30	KV
Junction temperature	T_J	125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics（T_a=25℃ Unless otherwise specified）

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				±5
Reverse leakage current	I_R	nA	V_{RWM} =5V			100
Reverse breakdown voltage	V_{BR}	V	I_{BR} = 1mA	5.3		
Clamping voltage [3]	V_{CL}	V	I_{PP} = 1A, t_p = 8/20μs			8
		V	I_{PP} = 8A, t_p = 8/20μs			12
Junction capacitance	C_J	pF	V_R = 0V, f = 1MHz		17	20

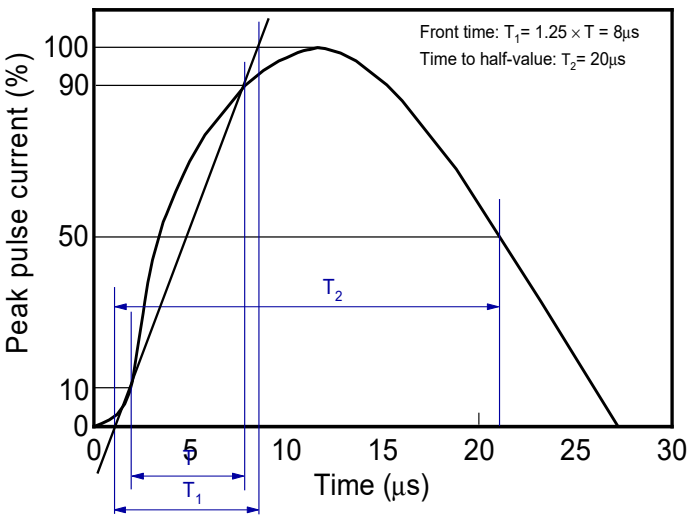
(1). TLP parameter: Z_0 = 50Ω, t_p = 100ns, t_r = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
(2). Contact discharge mode, according to IEC61000-4-2.
(3). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

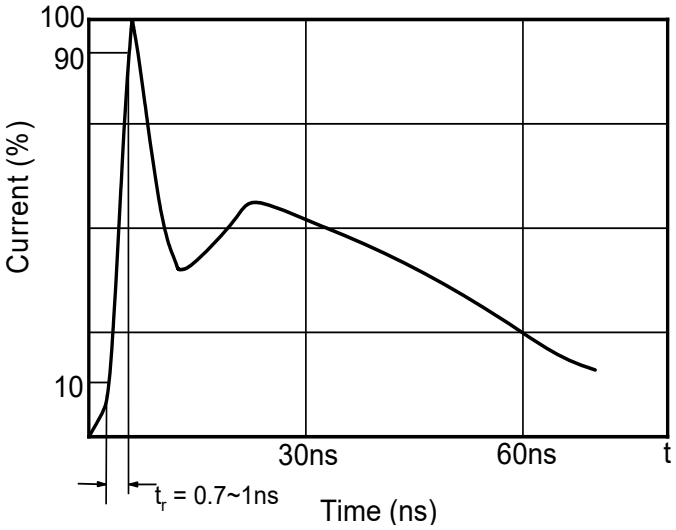
PREFERED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD5V0LB1	Approximate 0.9	10000	100000	400000	Tape & reel

■ Characteristics (Typical)

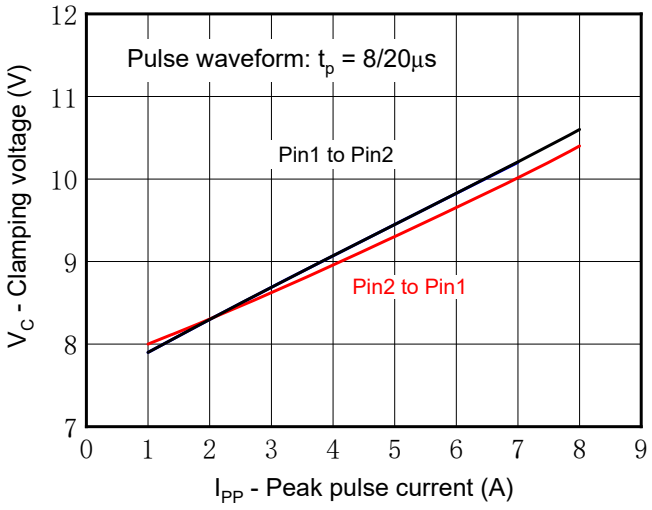
8/20μs waveform per IEC61000-4-5



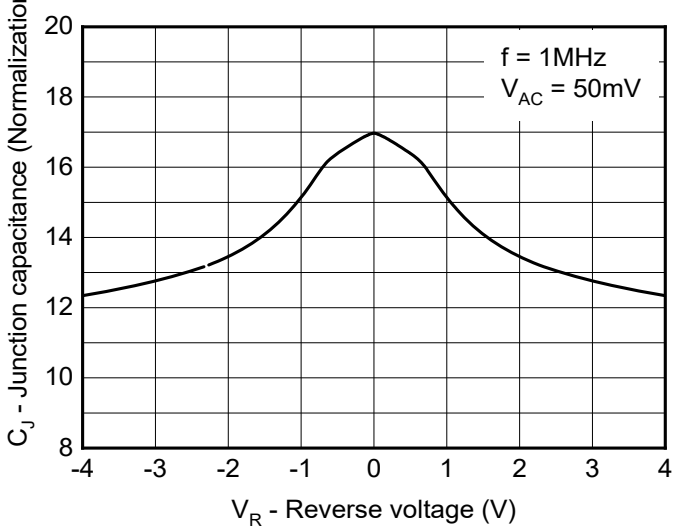
Contact discharge current waveform per IEC61000-4-2



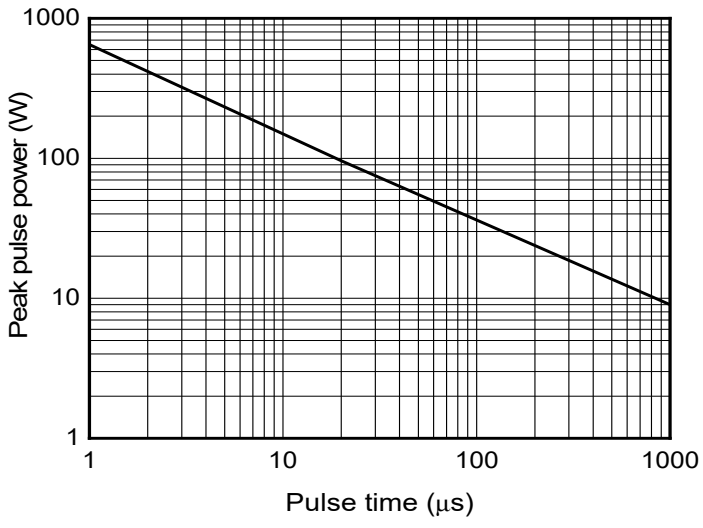
Clamping voltage vs. Peak pulse current



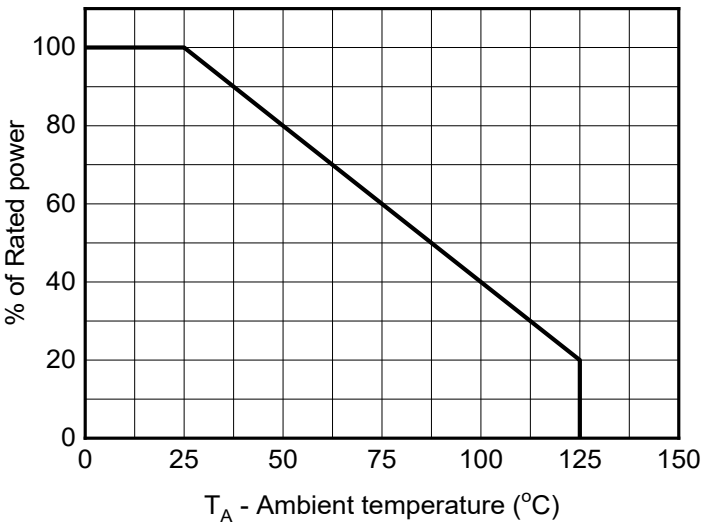
Capacitance vs. Reverse voltage



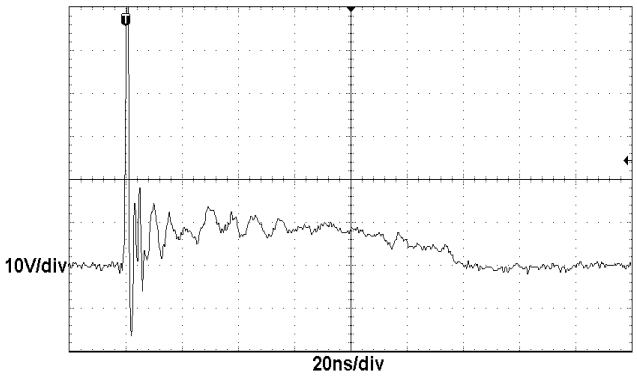
Non-repetitive peak pulse power vs. Pulse time



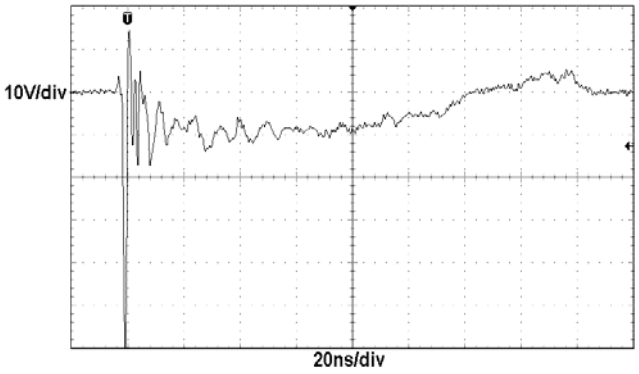
Power derating vs. Ambient temperature



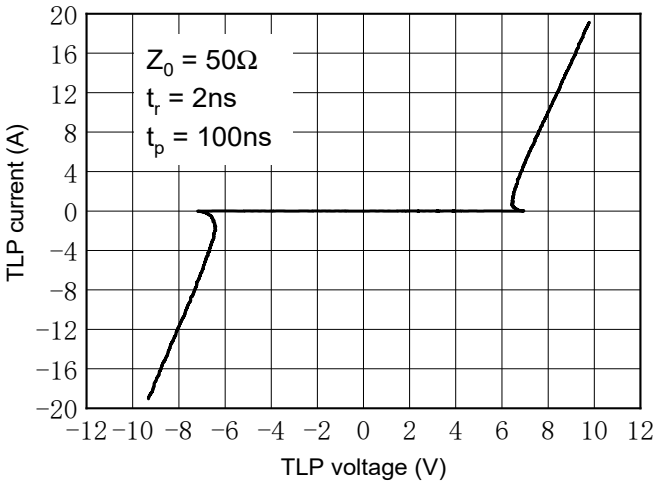
ESD clamping
(+8kV contact discharge per IEC61000-4-2)



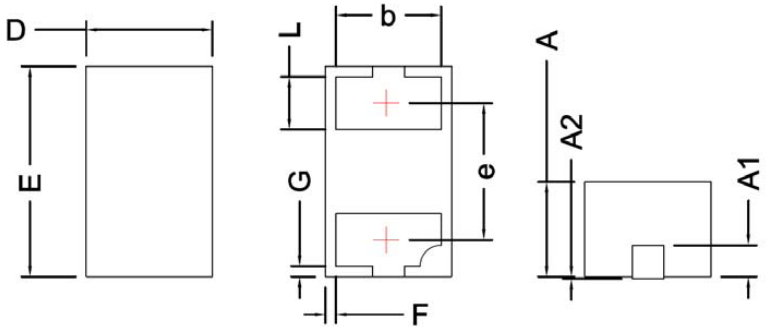
ESD clamping
(-8kV contact discharge per IEC61000-4-2)



TLP Measurement

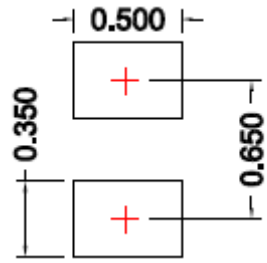


■ Outline Dimensions



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	0.50	0.60	0.70
E	0.90	1.00	1.10
A	0.35	0.45	0.55
A1		0.15 BSC	
A2			0.10
F	0.005		
G	0.005		
L	0.15	0.25	0.35
b	0.41	0.50	0.59
e		0.65 BSC	

■ Recommended PCB Layout



Unit:mm

Notes:
This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met

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